

-	98434	(benzotriazole carboxybenztriazole triazole bta! cbta! ta!)	USPAT; US-PGPUB	2003/05/22 18:45
-	2440	((benzotriazole carboxybenztriazole triazole bta! cbta! ta! ) same (mercaptobenzothizole ((thiocyanuric oleic linoleic) adj acid) benzimidazolethiol mbt! tca!)	USPAT; US-PGPUB	2003/05/22 18:46
-	14	(printed adj3 (wire wiring board circuit) ) and (((benzotriazole carboxybenztriazole triazole bta! cbta! ta! ) same (mercaptobenzothizole ((thiocyanuric oleic linoleic) adj acid) benzimidazolethiol mbt! tca!)) )	USPAT; US-PGPUB	2003/05/22 18:47
-	7817	430/311,313,314,328,945.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 17:06
-	373	yamamoto-takuya-.in. kataoka-takahi-.in. hirasawa-yutaka-.in. takahashi-naotomi-.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 17:07
-	260741	(printed adj3 (wire wiring board circuit) )	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 17:09
-	1012	(430/311,313,314,328,945.ccls. (yamamoto-takuya-.in. kataoka-takahi-.in. hirasawa-yutaka-.in. takahashi-naotomi-.in. ) and ((printed adj3 (wire wiring board circuit) ) )	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 17:45
-	48	((laser near2 (drill\$3 pattern\$3 ablat\$5)) ) with (((ni nickel ) near2 (foil sheet film layer coating)) ((co cobalt)) near2 (foil sheet film layer coating)) ((zn zinc)) near2 (foil sheet film layer coating)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:02
-	61	(laser near2 (drill\$3 pattern\$3 ablat\$5)) with ( ((ni nickel) near2 (layer film coating material)) ((co cobalt) near2 (layer film coating material)) ((zn zinc) near2 (layer film coating material)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:00
-	41	((laser near2 (drill\$3 pattern\$3 ablat\$5)) ) with ((metal metallic) near2 (foil sheet film layer coating))) same ((ni nickel ) (co cobalt) (zn zinc))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:26
-	6772067	((ni nickel ) (co cobalt) (zn zinc))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:02
-	102379	(cu copper) near2 (foil layer coating film sheet)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:02
-	26558	(laser near2 (drill\$3 pattern\$3 ablat\$5))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:03
-	21	( ((ni nickel ) (co cobalt) (zn zinc)) ) with ((cu copper) near2 (foil layer coating film sheet)) with ((laser near2 (drill\$3 pattern\$3 ablat\$5)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:16
-	83	(yamamoto-takuya-.in. kataoka-takahi-.in. hirasawa-yutaka-.in. takahashi-naotomi-.in. ) and ((printed adj3 (wire wiring board circuit) ) )	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:17

-	4	(yamamoto-takuya-.in. kataoka-takahi-.in. hirasawa-yutaka-.in. takahashi-naotomi-.in. ) and ((printed adj3 (wire wiring board circuit) ) ) and ((laser near2 (drill\$3 pattern\$3 ablat\$5))) and ( ((ni nickel ) (co cobalt) (zn zinc)) )	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:17
-	2	jp-2002019018-\$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/09 18:27
-	1	us-20030148136-\$.did. and (etch\$5 polish\$3 remov\$3 strip\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/14 16:24
-	1	us-20030148136-\$.did. and (clean\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/10/14 16:29